



DMG4468LFG

N-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound. • UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Page 5
- Ordering Information: See Page 5
- Weight: 0.0172 grams (approximate)

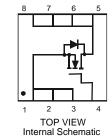
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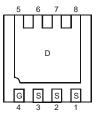




TOP VIEW

BOTTOM VIEW





BOTTOM VIEW Pin Configuration

Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | | | Symbol | Value | Unit |
|-----------------------------------|-----------------|------------------------------------------------|------------------|--------------|------|
| Drain-Source Voltage | | | V _{DSS} | 30 | V |
| Gate-Source Voltage | | | V _{GSS} | ±20 | V |
| Continuous Drain Current (Note 3) | Steady State | T _A = 25°C T _A = 85°C | ١ _D | 7.62 4.83 | А |
| Pulsed Drain Current (Note 4) | | | I _{DM} | 45.9 | А |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|-------------------------------------------------------------|------------------|-------------|------|
| Power Dissipation (Note 3) | PD | 0.99 | W |
| Thermal Resistance, Junction to Ambient @TA = 25°C (Note 3) | R _{0JA} | 126.7 | °C/W |
| Operating and Storage Temperature Range | TJ, TSTG | -55 to +150 | °C |

Notes: 1. No purposefully added lead.

Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
Device mounted on FR-4 PCB, with minimum recommended pad layout.

4. Repetitive rating, pulse width limited by junction temperature.

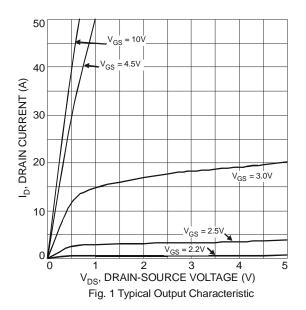


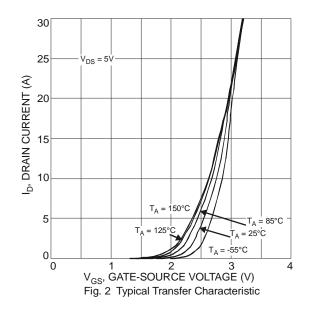
Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|-------------------------------------------------------|----------------------|------|-------|------|------|-------------------------------------------------------------------------|--|
| OFF CHARACTERISTICS (Note 5) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 30 | - | - | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current T _J = 25°C | I _{DSS} | - | - | 1.0 | μA | $V_{DS} = 30V, V_{GS} = 0V$ | |
| Gate-Source Leakage | IGSS | - | - | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 5) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 1.0 | - | 2.0 | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | |
| Static Drain-Source On-Resistance | P | N) - | 10 1 | 15 | mΩ | $V_{GS} = 10V, I_D = 11.6A$ | |
| Static Drain-Source On-Resistance | R _{DS (ON)} | | 17 | 23.5 | 1112 | $V_{GS} = 4.5V, I_D = 10A$ | |
| Forward Transfer Admittance | Y _{fs} | - | 8 | - | S | V _{DS} = 10V, I _D = 9A | |
| Diode Forward Voltage | V _{SD} | - | 0.7 | 1.0 | V | $V_{GS} = 0V, I_{S} = 1A$ | |
| DYNAMIC CHARACTERISTICS (Note 6) | | | | | | | |
| Input Capacitance | Ciss | - | 867 | - | рF | | |
| Output Capacitance | Coss | - | 85 | - | рF | $V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | - | 81 | - | рF | 1 = 1.0MH2 | |
| Gate Resistance | R _g | - | 1.39 | - | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge | Qg | - | 18.85 | - | nC | V _{GS} = 10V, V _{DS} = 15V, I _D = 11.6A | |
| Gate-Source Charge | Q _{gs} | - | 2.59 | - | nC | | |
| Gate-Drain Charge | Q _{gd} | - | 6.15 | - | nC | | |
| Turn-On Delay Time | t _{D(on)} | - | 5.46 | - | ns | | |
| Turn-On Rise Time | tr | - | 14.53 | - | ns | $V_{DD} = 15V, V_{GS} = 10V,$ | |
| Turn-Off Delay Time | t _{D(off)} | - | 18.84 | - | ns | $R_L = 1.3\Omega, R_G = 3\Omega,$ | |
| Turn-Off Fall Time | t _f | - | 6.01 | - | ns | $I_D = 1A$ | |

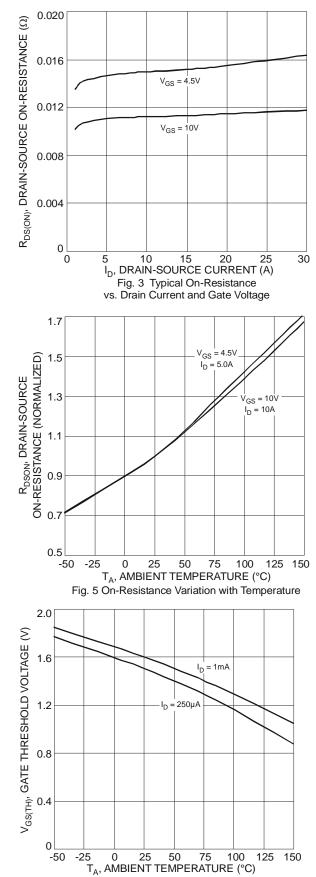
Notes:

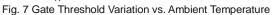
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

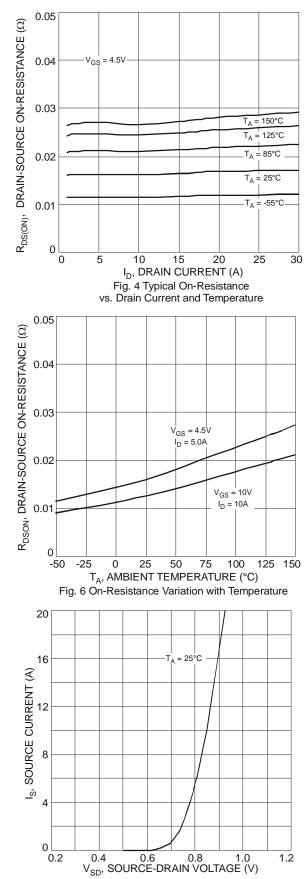






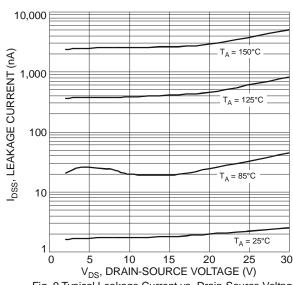




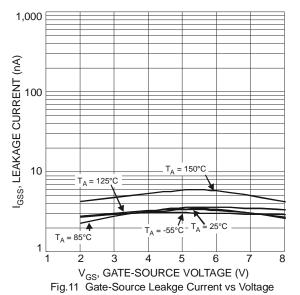


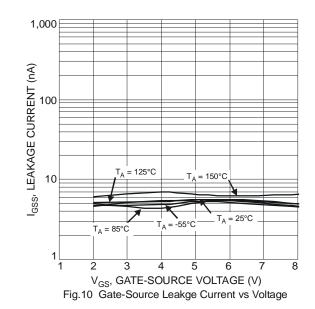


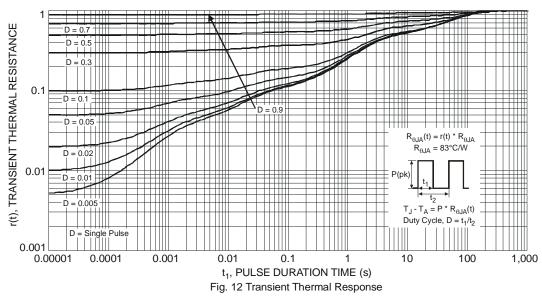
NEW PRODUCT













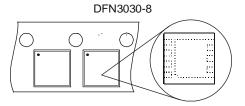
| Ordering Information (Note 7) | | | | |
|-------------------------------|-----------|--------------------|--|--|
| Part Number | Case | Packaging | | |
| DMG4468LFG-7 | DFN3030-8 | 3000 / Tape & Reel | | |

Notes: 7. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

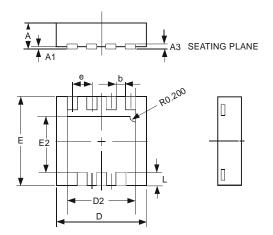
Marking Information



N45 = Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year, ex: 09 for 2009 WW = Week code 01 to 52

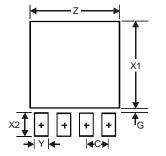


Package Outline Dimensions



| DFN3030-8 | | | | |
|----------------------|------|------|------|--|
| Dim | Min | Max | Тур | |
| Α | 0.57 | 0.63 | 0.60 | |
| A1 | 0 | 0.05 | 0.02 | |
| A3 | | | 0.15 | |
| b | 0.29 | 0.39 | 0.34 | |
| D | 2.90 | 3.10 | 3.00 | |
| D2 | 2.19 | 2.39 | 2.29 | |
| e | | _ | 0.65 | |
| Е | 2.90 | 3.10 | 3.00 | |
| E2 | 1.64 | 1.84 | 1.74 | |
| L | 0.30 | 0.60 | 0.45 | |
| All Dimensions in mm | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.59 |
| G | 0.11 |
| X1 | 2.49 |
| X2 | 0.65 |
| Y | 0.39 |
| С | 0.65 |



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